

## Electronic Acknowledgement Receipt

<b>EFS ID:</b>	4380757
<b>Application Number:</b>	10537509
<b>International Application Number:</b>	
<b>Confirmation Number:</b>	4531
<b>Title of Invention:</b>	Method for cutting semiconductor substrate
<b>First Named Inventor/Applicant Name:</b>	Fumitsugu Fukuyo
<b>Customer Number:</b>	23973
<b>Filer:</b>	Joseph John Buczynski/Towanna Bolling
<b>Filer Authorized By:</b>	Joseph John Buczynski
<b>Attorney Docket Number:</b>	46884-5388 (211285)
<b>Receipt Date:</b>	02-DEC-2008
<b>Filing Date:</b>	30-NOV-2005
<b>Time Stamp:</b>	16:03:08
<b>Application Type:</b>	U.S. National Stage under 35 USC 371

### Payment information:

Submitted with Payment	yes
Payment Type	Credit Card
Payment was successfully received in RAM	\$180
RAM confirmation Number	1069
Deposit Account	500573
Authorized User	SMITH,JOHN

The Director of the USPTO is hereby authorized to charge indicated fees and credit any overpayment as follows:

Charge any Additional Fees required under 37 C.F.R. 1.492 (National application filing, search, and examination fees)

Charge any Additional Fees required under 37 C.F.R. Section 1.17 (Patent application and reexamination processing fees)

Charge any Additional Fees required under 37 C.F.R. Section 1.19 (Document supply fees)

Charge any Additional Fees required under 37 C.F.R. Section 1.20 (Post Issuance fees)

Charge any Additional Fees required under 37 C.F.R. Section 1.21 (Miscellaneous fees and charges)

### File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/Message Digest	Multi Part /.zip	Pages (if appl.)
1		46884_5388_ids.pdf	91433 071321b823527d53b5ea67200660bae2a1 97cef8	yes	3
<b>Multipart Description/PDF files in .zip description</b>					
<b>Document Description</b>		<b>Start</b>		<b>End</b>	
Information Disclosure Statement Letter		1		2	
Information Disclosure Statement (IDS) Filed (SB/08)		3		3	

### Warnings:

### Information:

2	NPL Documents	46884_5388_321oaref.pdf	318376 b05664637b2c2e7aaab21c272beda06a612 694e7	no	12
---	---------------	-------------------------	--	----	----

### Warnings:

### Information:

3	NPL Documents	46884_5388_340oaref.pdf	258340 4ce5e0b0f0d82f5a5f4688c7610b5b3163ca 5020	no	11
---	---------------	-------------------------	--	----	----

### Warnings:

### Information:

4	Fee Worksheet (PTO-06)	fee-info.pdf	30359 859849e2b07ffcc46f6ab1a17fcac9ba23953 466	no	2
---	------------------------	--------------	---	----	---

### Warnings:

### Information:

**Total Files Size (in bytes):** 698508

This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.

**New Applications Under 35 U.S.C. 111**

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

**National Stage of an International Application under 35 U.S.C. 371**

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

**New International Application Filed with the USPTO as a Receiving Office**

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.